Appl. No. 09/893,356

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

| Applicant: | Marcos KARNEZOS, et al.           | )                               |
|------------|-----------------------------------|---------------------------------|
|            | n No.: 09/893,356                 | Examiner: Ngan V. NGO           |
| Filed:     | June 26, 2001                     | ) Group Art Unit: 2814          |
| Title:     | Integral heatsink ball grid array | Date: <u>September 12, 2003</u> |
|            |                                   | CERTIFICATE OF MAILING          |

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first class mail in an envelope addressed to:

Commissioner for Patents, P.O. Box 1450, Alexandria VA 22313-1450, on September 12, 2003.

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

**AMENDMENT** 

Dear Sir:

Responsive to the Office action, made Final, mailed May 12, 2003, kindly amend the ation as follows: application as follows:

There are no amendments to the claims; a Listing of Claims begins on page 2 of this paper.

Remarks begin on page 4 of this paper.